



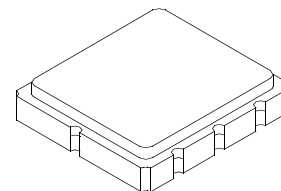
For prototype or pre-production sample please contact RFM Sales.

- **Designed for Broadband Receiver IF Applications**
- **Low Insertion Loss**
- **5.0 X 5.0 mm Surface-Mount Case**
- **Differential Input and Output**
- **Complies with Directive 2002/95/EC (RoHS)**



SF2072C

360.00 MHz SAW Filter



SM5050-8

Absolute Maximum Ratings

Rating	Value	Units
Maximum Incident Power in Passband	+13	dBm
Max. DC voltage between any 2 terminals	30	VDC
Storage Temperature Range	-40 to +85	°C
Suitable for lead-free soldering - Max Soldering Profile	260°C for 30 s	

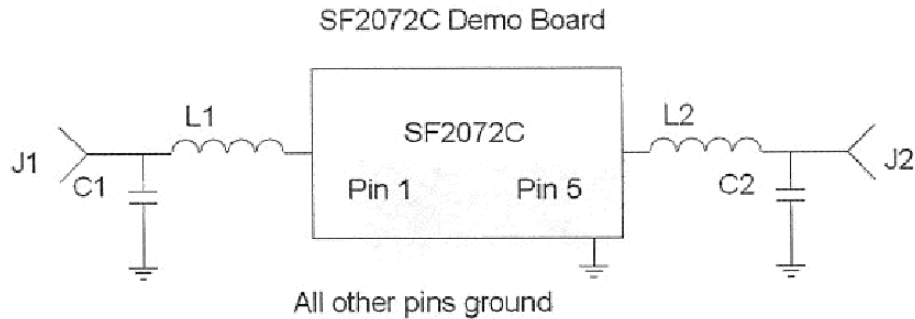
Electrical Characteristics

Characteristic	Sym	Notes	Min	Typ	Max	Units
Nominal Center Frequency	CF			360.00		MHz
Insertion Loss				9	10.5	dB
Bandwidth 1 dB			30	36		MHz
Bandwidth 3 dB			36	40		MHz
Amplitude Ripple across 30 MHz				0.4		dB
Amplitude Ripple across any 10 MHz				0.75		dB
VSWR across fc ±15 MHz				1.7	2.2	
Group Delay Variation				40		nsec
100 to 285 MHz 285 to 325 MHz 325 to 435 MHz 435 to ++				50		dB
			25	38		
			25	38		
				45		
Center Frequency Temperature Coefficient				-34		kHz/°C
Temperature Operating			-40		85	°C
Case Style		SM5050-8 5 x 5 mm Nominal Footprint				
Lid Symbolization (YY=year, WW=week, S=shift)		RFM 649 YYWWS				

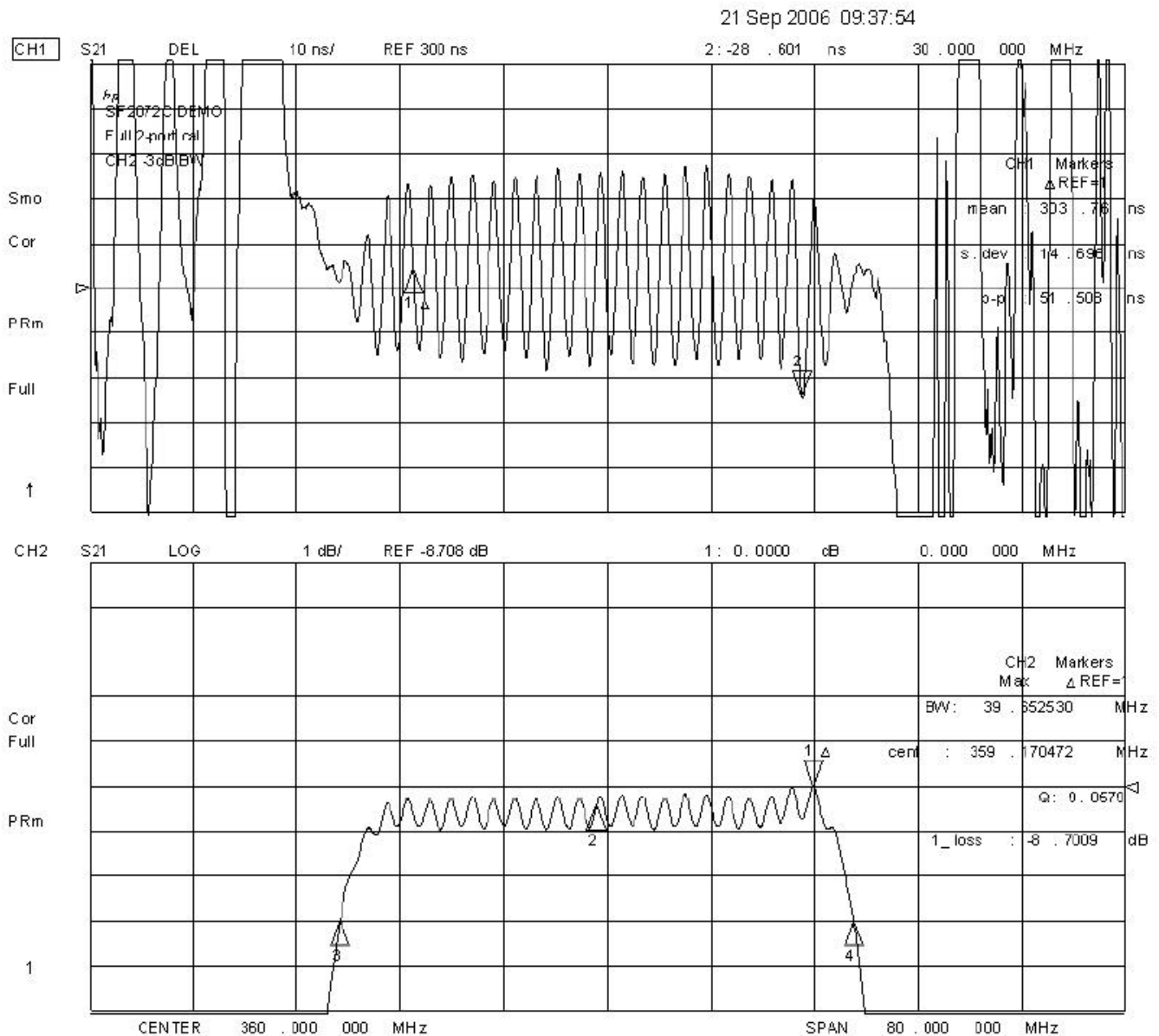
Notes:

1. Unless noted otherwise, all specifications apply over the operating temperature range with filter soldered to the specified demonstration board with impedance matching to 50 Ω and measured with 50 Ω network analyzer.
2. Rejection is measured as attenuation below the minimum IL point in the passband. Rejection in final user application is dependent on PCB layout and external impedance matching design. See Application Note No. 42 for details.
3. The design, manufacturing process, and specifications of this filter are subject to change.
4. Tape and Reel Standard ANSI / EIA 481.
5. US and international patents may apply.
6. RFM, stylized RFM logo, and RF Monolithics, Inc. are registered trademarks of RF Monolithics, Inc.
7. ©Copyright 1999, RF Monolithics Inc.
8. Electrostatic Sensitive Device. Observe precautions for handling.
9. The center of the bandwidths will move with ambient temperature.





J1, J2=500-0248-001 4 Hole Flange SMA
 PCB=400-1592-001 Pin 1&5 Type 2 5x5
 C1,C2=10 pF 500-0003-100
 L1=33 nH 0805CS 500-0782-330
 L2=36 nH 0805CS 500-0782-360



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CH1 S11 1 UFS

1: 70.449 Ω -31.391 Ω 14.064 pF 360.000 000 MHz

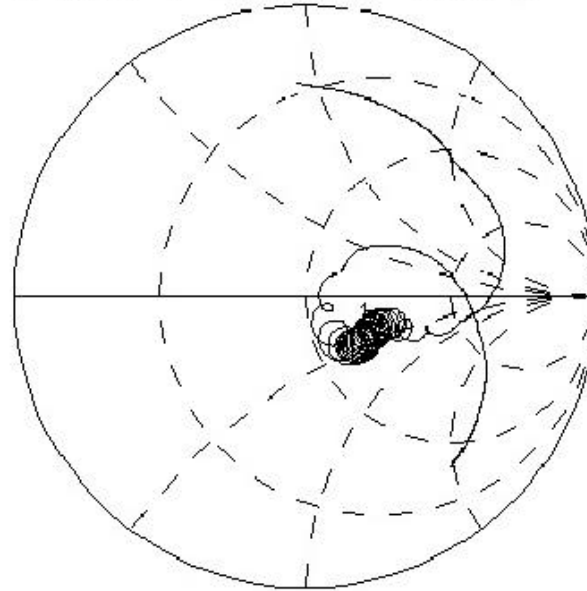
hp
SF2072C DEMO
Full 2-port cal

Cor

PRm

Full

↑



CH2 S22 1 UFS

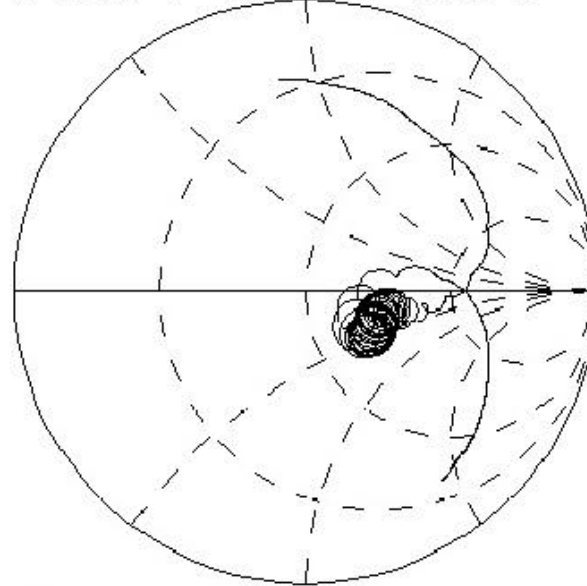
1: 79.523 Ω -32.938 Ω 13.422 pF 360.000 000 MHz

Cor

Full

PRm

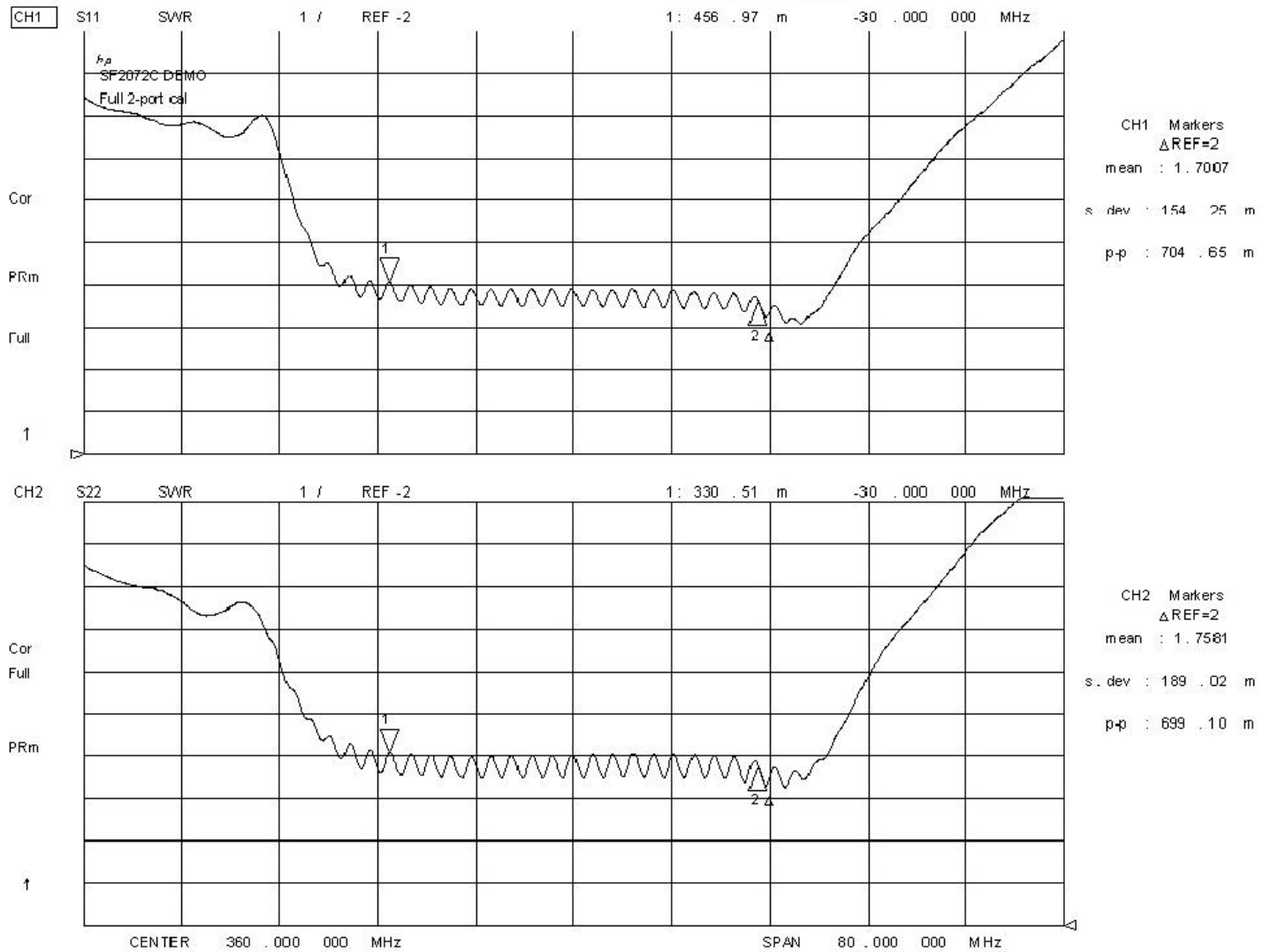
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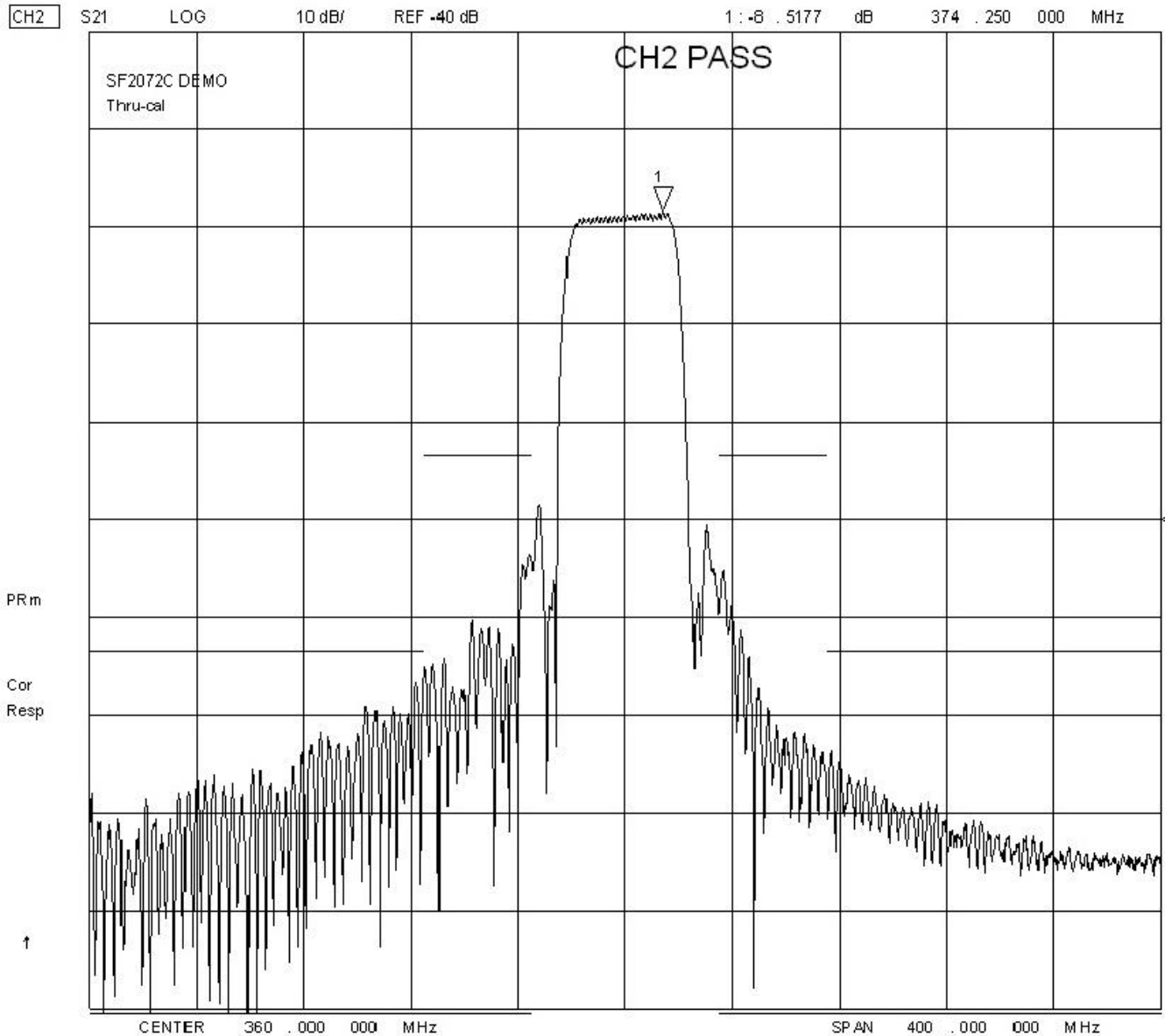
CENTER 360.000 000 MHz

SPAN 80.000 000 MHz

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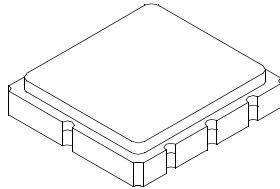


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SM5050-8 Case

8-Terminal Ceramic Surface-Mount Case
5.0 X 5.0 mm Nominal Footprint



Case Dimensions

Dimension	mm			Inches		
	Min	Nom	Max	Min	Nom	Max
A	4.8	5.0	5.2		0.1968	
B	4.8	5.0	5.2		0.1968	
C			1.7			0.0669
D		2.08			0.0818	
E		1.17			0.046	
F		0.64			0.0252	
G	2.39	2.54	2.69		0.100	

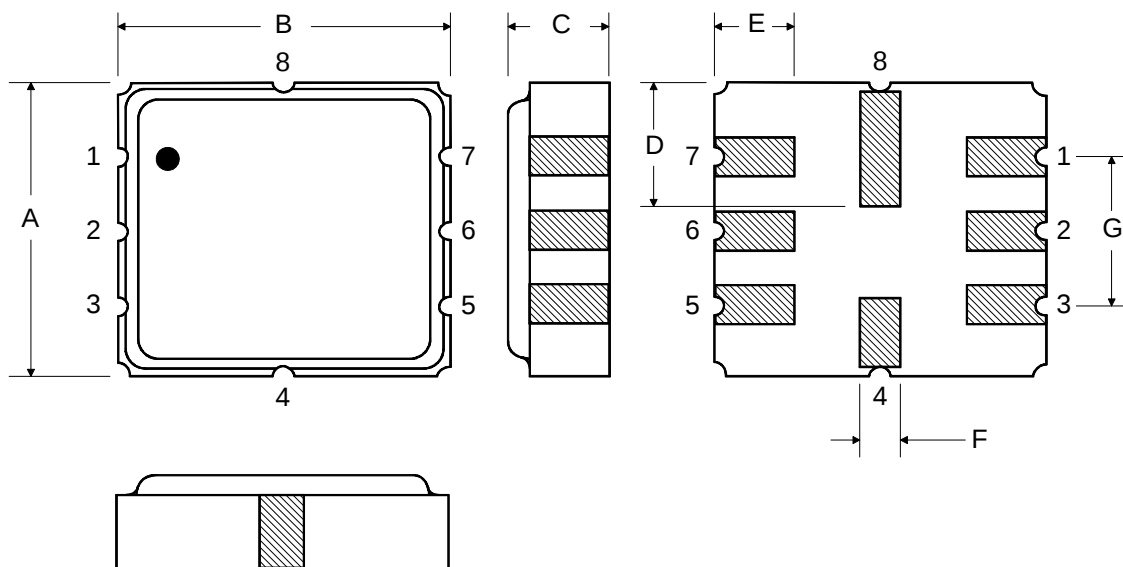
Materials	
Solder Pad Termination	Au plating 30 - 60 ulnches (76.2-152 uM) over 80-200 ulnches (203-508 uM) Ni.
Lid	Fe-Ni-Co Alloy Electroless Nickel Plate (8-11% Phosphorus) 100-200 ulnches Thick
Body	Al ₂ O ₃ Ceramic
Pb Free	

Electrical Connections

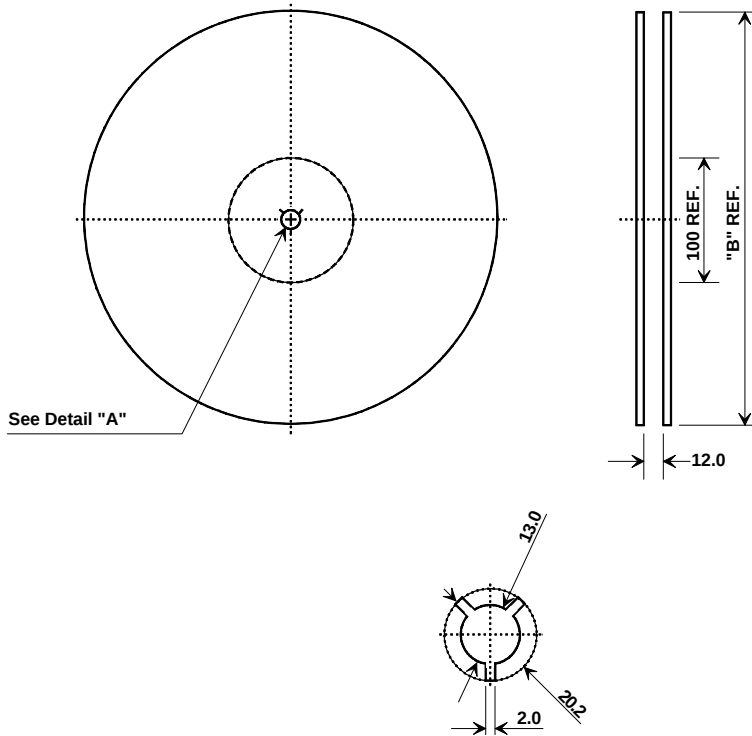
Connection		Terminals
Port 1	Differential Input	2,3
Port 2	Differential Output	6,7
	Ground	All others
Single Ended Operation		Return is ground
Differential Operation		Return is hot
Dot indicates Pin 1		

TOP VIEW

BOTTOM VIEW



Tape and Reel Specifications



"B "		Quantity Per Reel
Inches	millimeters	
7	178	500
13	330	2000

COMPONENT ORIENTATION and DIMENSIONS

Carrier Tape Dimensions	
Ao	5.3 mm
Bo	5.3 mm
Ko	2.0 mm
Pitch	8.0 mm
W	12.0 mm

